IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Chii-Ming WU, et al. § Confirmation No. 9336 8 Serial No.: 10/657,505 § Group Art Unit: 2812 § Filed: September 8, 2003 § Examiner: Gever, Scott B. 9999 For: Method of Manufacturing a Contact Attorney Docket No.: Interconnection Layer Containing a Metal and TS01-1247 / 24061.406 Nitrogen by Atomic Layer Deposition for Deep Sub-Micron Semiconductor Technology §

Commissioner for Patents Mail Stop Amendment P.O. Box 1450 Alexandria, VA 22313-1450

Certificate of Service I hereby certify that this correspondence is being filed with the U.S. Patent and Trademark Office via EFS-Web on July 27, 2006. Linda Ingram

AMENDMENT

Sir:

The Commissioner is hereby authorized to charge any fees required for entry of this paper, including those for any extensions of time, to Haynes and Boone LLP's Deposit Account No. 08-1394. Applicants are enclosing a Petition for a one-month time extension.

In response to the Office Action of April 3, 2006, please amend the above-identified application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 7 of this paper.